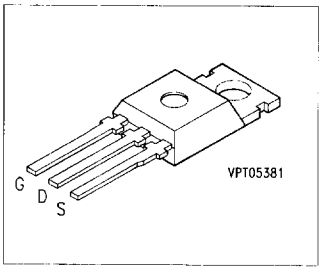
SIEMENS

SIPMOS® Power Transistors

BUZ 91
BUZ 91 A

- N channel
- Enhancement mode
- Avalanche-rated



Type	V_{DS}	I_D	T_C	$R_{DS\,(on)}$	Package [1]	Ordering Code
BUZ 91	600 V	8.5 A	32 °C	0.8 Ω	TO-220 AB	C67078-S1342-A2
BUZ 91 A	600 V	8.0 A	33 °C	0.9 Ω	TO-220 AB	C67078-S1342-A3

Maximum Ratings

Parameter	Symbol	BUZ		Unit
		91	91 A	
Continuous drain current	I_D	**8.5**	**8.0**	A
Pulsed drain current, T_C = 25 °C	$I_{D\,puls}$	**34**	**32**	
Avalanche current, limited by $T_{j\,max}$	I_{AR}	**8.0**		
Avalanche energy, periodic limited by $T_{j\,(max)}$	E_{AR}	**13**		mJ
Avalanche energy, single pulse I_D = 8 A, V_{DD} = 50 V, R_{GS} = 25 Ω L = 16.3 mH, T_j = 25 °C	E_{AS}	**570**		
Gate-source voltage	V_{GS}	**± 20**		V
Power dissipation, T_C = 25 °C	P_{tot}	**150**		W
Operating and storage temperature range	T_j , T_{stg}	**– 55 ... + 150**		°C

Thermal resistance, chip-case	$R_{th\,JC}$	**≤ 0.83**	K/W
DIN humidity category, DIN 40 040		**E**	–
IEC climatic category, DIN IEC 68-1		**55/150/56**	

1) See chapter Package Outlines.

Electrical Characteristics

at T_j = 25 °C, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static characteristics					
Drain-source breakdown voltage V_{GS} = 0 V, I_D = 0.25 mA	$V_{(BR)\,DSS}$	600	–	–	V
Gate threshold voltage $V_{GS} = V_{DS}$, I_D = 1 mA	$V_{GS\,(th)}$	2.1	3.0	4.0	
Zero gate voltage drain current V_{DS} = 600 V, V_{GS} = 0 V T_j = 25 °C T_j = 125 °C	I_{DSS}	 – –	 0.1 10	 1.0 100	µA
Gate-source leakage current V_{GS} = 20 V, V_{DS} = 0 V	I_{GSS}	–	10	100	µA
Drain-source on-resistance V_{GS} = 10 V, I_D = 5.0 A	$R_{DS\,(on)}$	–	0.7	0.8	Ω
Dynamic characteristics					
Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$, I_D = 5.0 A	g_{fs}	5.0	8.5	–	S
Input capacitance V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	C_{iss}	–	1400	2100	pF
Output capacitance V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	C_{oss}	–	180	270	
Reverse transfer capacitance V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	C_{rss}	–	65	100	
Turn-on time t_{on} , ($t_{on} = t_{d\,(on)} + t_r$) V_{CC} = 30 V, V_{GS} = 10 V, I_D = 3.0 A, R_{GS} = 50 Ω	$t_{d\,(on)}$	–	20	30	ns
	t_r	–	70	110	
Turn-off time t_{off} , ($t_{off} = t_{d\,(off)} + t_f$) V_{CC} = 30 V, V_{GS} = 10 V, I_D = 3.07 A, R_{GS} = 50 Ω	$t_{d\,(off)}$	–	250	330	
	t_f	–	80	100	

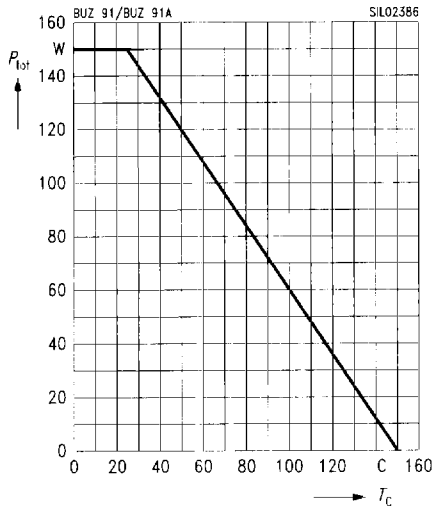
Electrical Characteristics (cont'd)
at T_j = 25 °C, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse diode					
Continuous reverse drain current	I_S				A
T_C = 25 °C BUZ 91		–	–	8.5	
BUZ 91 A		–	–	8.0	
Pulsed reverse drain current	I_{SM}	–			
T_C = 25 °C BUZ 91			–	34	
BUZ 91 A			–	32	
Diode forward on-voltage I_S = 16 A, V_{GS} = 0 V	V_{SD}	–	1.1	1.2	V
Reverse recovery time V_R = 100 V, $I_F = I_S$, di_F / dt = 100 A/µs	t_{rr}	–	480	–	ns
Reverse recovery charge V_R = 100 V, $I_F = I_S$, di_F / dt = 100 A/µs	Q_{rr}	–	6.5	–	µC

Characteristics at T_j = 25 °C, unless otherwise specified.

Total power dissipation

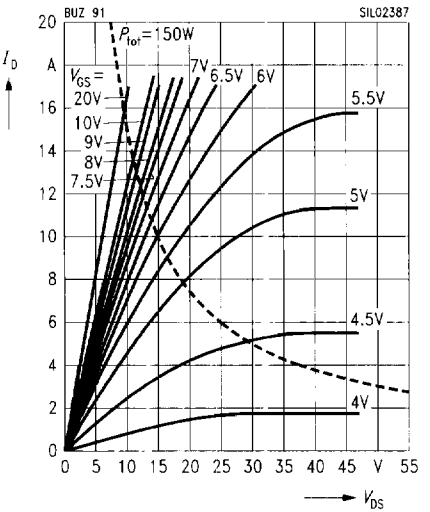
$P_{tot} = f(T_C)$



Typ. output characteristics

$I_D = f(V_{DS})$ **BUZ 91**

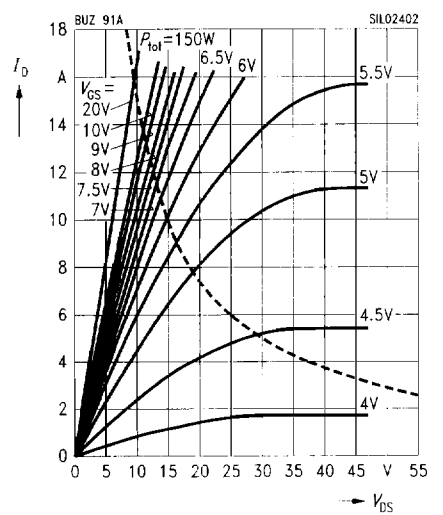
parameter: t_p = 80 µs



Typ. output characteristics

$I_D = f(V_{DS})$ **BUZ 91 A**

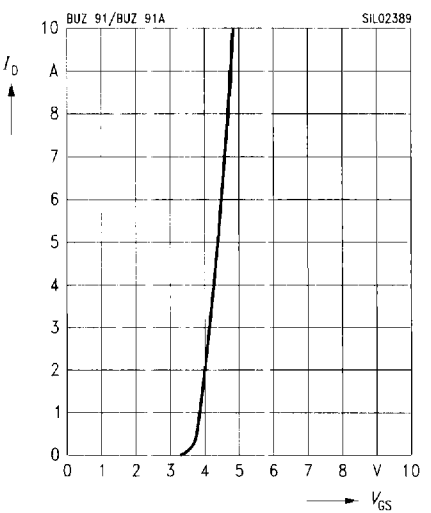
parameter: t_p = 80 µs



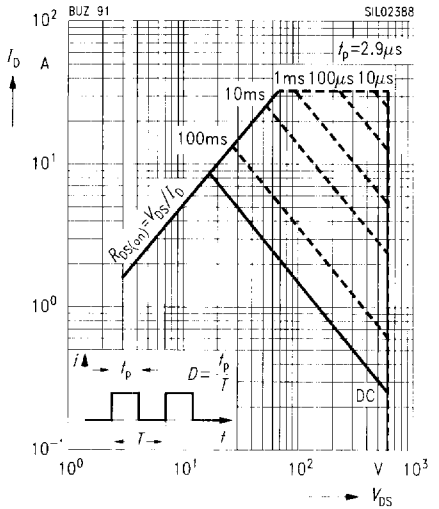
Typ. transfer characteristics

$I_D = f(V_{GS})$

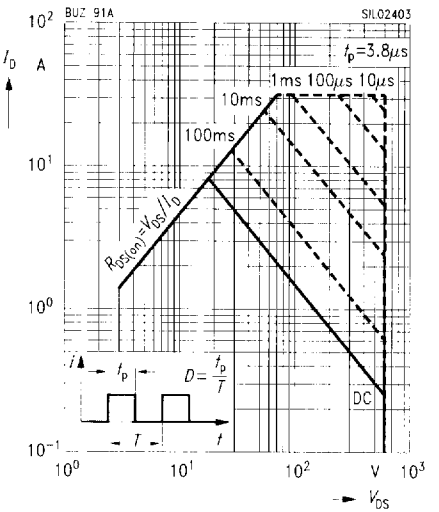
parameter: t_p = 80 µs, V_{DS} = 25 V



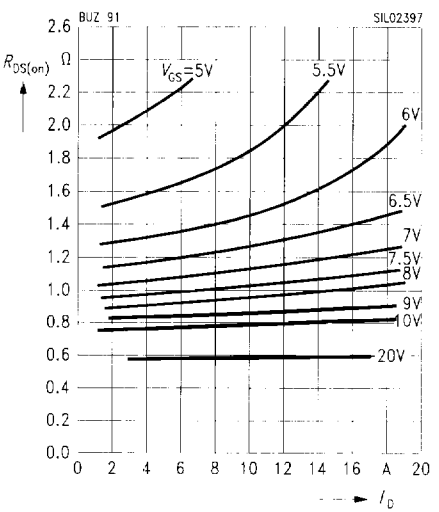
Safe operating area
$I_D = f(V_{DS})$ **BUZ 91**
parameter: $D = 0.01$, $T_C = 25$ °C



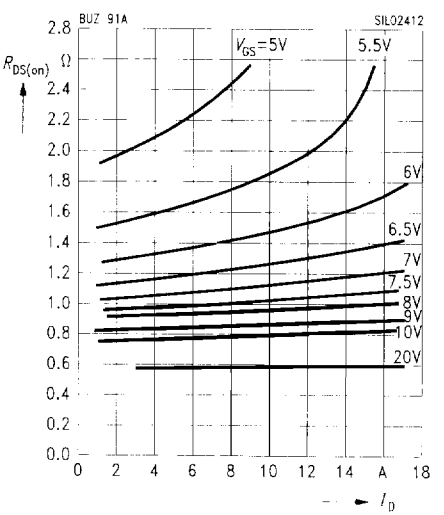
Safe operating area
$I_D = f(V_{DS})$ **BUZ 91 A**
parameter: $D = 0.01$, $T_C = 25$ °C



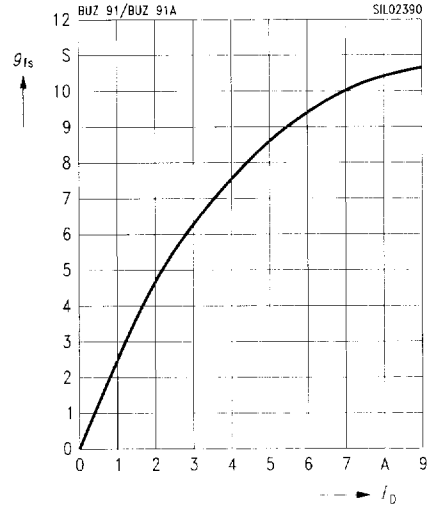
Typ. drain-source on-resistance
$R_{DS\,(on)} = f(I_D)$ **BUZ 91**
parameter: V_{GS}



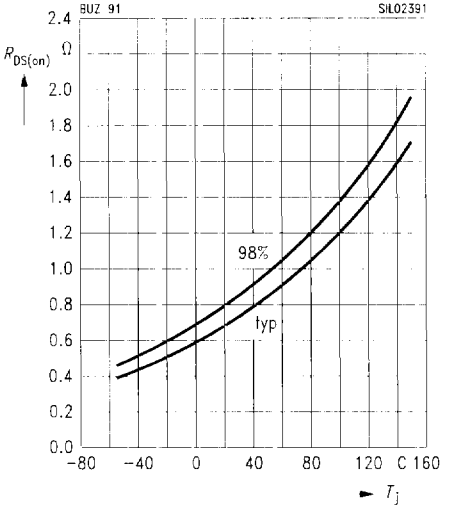
Typ. drain-source on-resistance
$R_{DS\,(on)} = f(I_D)$ **BUZ 91 A**
parameter: V_{GS}



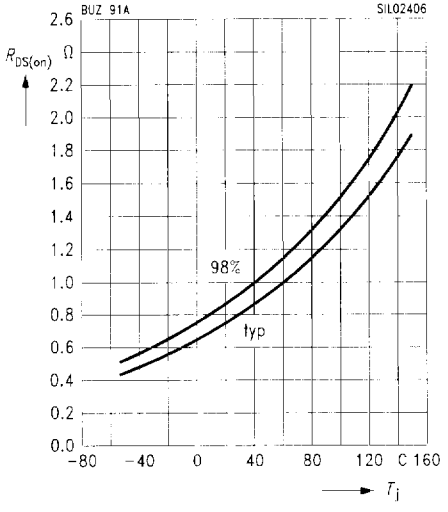
Typ. forward transconductance
$g_{fs} = f(I_D)$
parameter: t_p = 80 µs



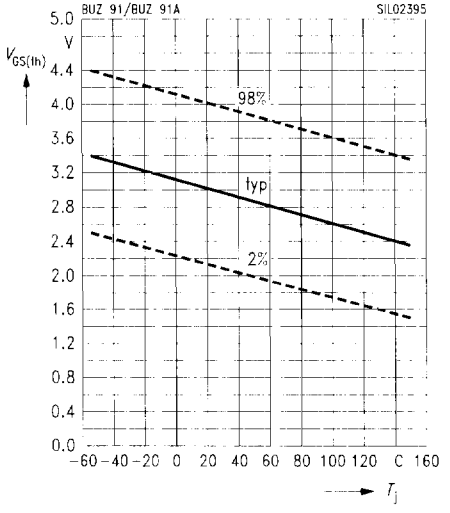
Drain-source on-resistance
$R_{DS\,(on)} = f(T_j)$ **BUZ 91**
parameter: I_D = 5 A, V_{GS} = 10 V, (spread)



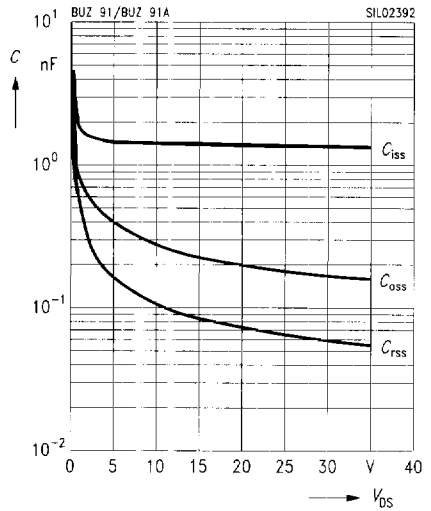
Drain-source on-resistance
$R_{DS\,(on)} = f(T_j)$ **BUZ 91 A**
parameter: I_D = 5 A, V_{GS} = 10 V, (spread)



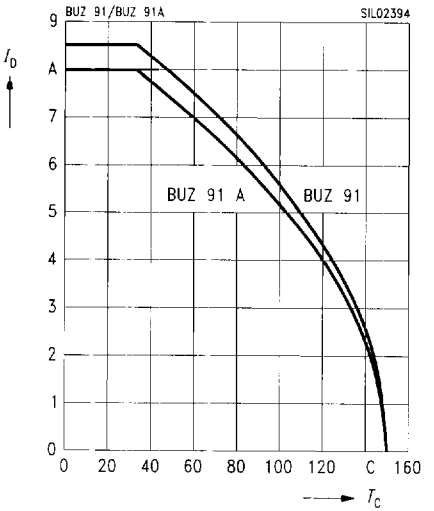
Gate threshold voltage
$V_{GS\,(th)} = f(T_j)$
parameter: $V_{GS} = V_{DS}$, I_D = 1 mA, (spread)



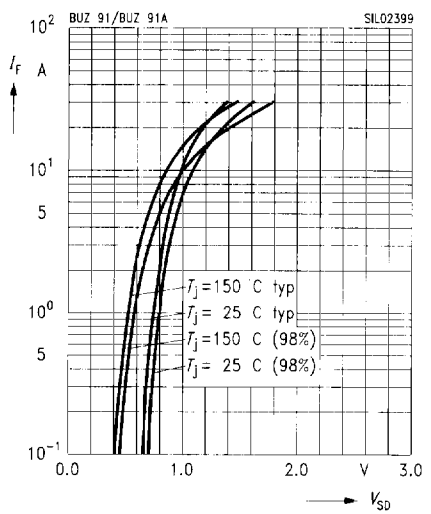
Typ. capacitances
$C = f(V_{DS})$
parameter: V_{GS} = 0 V, f = 1 MHz



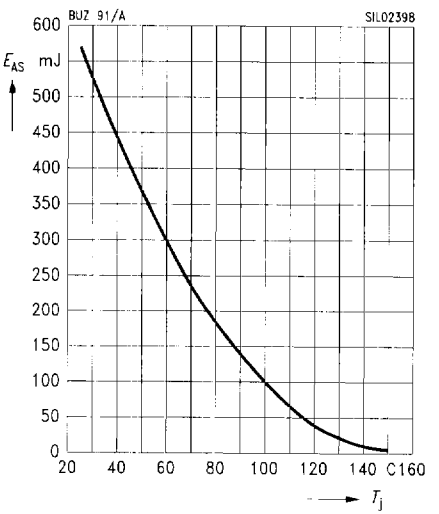
Drain current
$I_D = f(T_C)$
parameter: $V_{GS} \geq 10$ V



Forward characteristics of reverse diode
$I_F = f(V_{SD})$
parameter: T_j , t_p = 80 µs, (spread)



Avalanche energy $E_{AS} = f(T_j)$
parameter: I_D = 8 A, V_{DD} = 50 V
R_{GS} = 25 Ω, L = 16.3 mH



Transient thermal impedance

$Z_{th\,JC} = f(t_p)$

parameter: $D = t_p / T$